

COMBINED DECLARATION FOR PATENT APPLICATION AND POWER OF ATTORNEY

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name. I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled: **NITRIDE SEMICONDUCTOR DEVICE**. The specification of which is attached hereto. I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)			Priority Claim	
			Yes	No
PCT/JP98/03336	Japan	7/27/98	X	
Number	Country	Day/Month/Year Filed		
199471/1997	Japan	7/25/97	X	
Number	Country	Day/Month/Year Filed		
235524/1997	Japan	9/1/97	X	
Number	Country	Day/Month/Year Filed		
286304/1997	Japan	10/20/97	X	
Number	Country	Day/Month/Year Filed		
304328/1997	Japan	11/6/97	X	
Number	Country	Day/Month/Year Filed		
317421/1997	Japan	11/18/97	X	
Number	Country	Day/Month/Year Filed		
348972/1997	Japan	12/18/97	X	
Number	Country	Day/Month/Year Filed		
348973/1997	Japan	12/18/97	X	
Number	Country	Day/Month/Year Filed		
176623/1998	Japan	6/8/98	X	
Number	Country	Day/Month/Year Filed		
176634/1998	Japan	6/8/98	X	
Number	Country	Day/Month/Year Filed		
199829/1998	Japan	6/29/98	X	
Number	Country	Day/Month/Year Filed		

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Application Serial No.	Filing Date	Status: Patented, Pending, Abandoned
I hereby appoint the following as my attorneys with full power of substitution to prosecute this application and transact all business in the Patent and Trademark Office in connection therewith:		
Thomas B. Haverstock	32,571	Jonathan O. Owens 37,902

Please direct all correspondence regarding this application to the following:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Inventor's Signature: _____ Date _____

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Full Name of Fourth Joint Inventor: Tomotsugu Mitani

Inventor's Signature: _____

Date

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Date

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